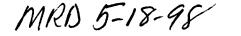
05-29-1998





ibel No. EG671959698US

DOCKET NO. P-3509

100721996

PATENTO

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants:

Nicholas F. Pasch and Rajat Rakkhit

Assignee:

LSI Logic Corporation

Title:

INTEGRATED CIRCUIT STRUCTURE WITH THIN DIELECTRIC BETWEEN AT LEAST LOCAL INTERCONNECT LEVEL AND FIRST METAL INTERCONNECT LEVEL, AND PROCESS FOR

MAKING SAME

Serial No.:

Unknown

Filed:

Herewith

Group Art Unit: Unknown

Attorney Docket No. P-3509

Examiner: Unknown

May 18, 1998

RECORDATION FORM COVER SHEET PATENTS ONLY

To the Honorable Commissioner of Patents and Trademarks Washington, DC 20231

Sir:

Please record the attached original documents or copy thereof.

Name of conveying party(ies): 1.

Nicholas F. Pasch

Date of Execution:

Rajat Rakkhit

Date of Execution: April 29, 1998

Name and address of receiving party(ies): 2.

> LSI Logic Corporation 1551 McCarthy Boulevard Milpitas, California 95035 U.S.A.

> > 1

3.	Nature of conveyance: Assignment			
4.	Application number(s) or patent number(s): If this document is being filed together with a new application, the execution date of the application is: May 14, 1998 and April 29, 1998.			
	A. Patent Application Serial Number: B. Patent Number:			
5.	Name and address of party to whom correspondence concerning document should be mailed:			
	John P. Taylor Post Office Box 1598 Temecula, California 92593-1598 U.S.A.			
6.	Total number of applications and patents involved: 1.			
7.	Total fee (37 CFR 3.41): <u>\$40.00.</u>			
8.	Attached is a check in the amount of \$40.00.			
	Charge Deposit Account No in the amount of \$ (A duplicate copy of this document is enclosed.)			
9.	Statement and Signature: To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document. John P. Taylor Reg. No. 22,369			
10.	Total number of pages including cover sheet, attachments and document:3			

Docket No.: P-3509 Patent

ASSIGNMENT

For good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I/WE, the undersigned, Nicholas F. Pasch and Rajat Rakkhit, do hereby sell, assign, and transfer to: LSI LOGIC CORPORATION, a corporation of Delaware, having a place of business at 1551 McCarthy Boulevard, Milpitas, California 95035, ("Assignee"), its successors, assigns, and legal representatives, the entire right, title and interest for the United States and all foreign countries, in and to any and all inventions and improvements which are disclosed in the application for United States Letters Patent,

Letters Patent,			
(X) which has been exect which was filed on			
INTERCONNECT LEVEL AND FIRST M to said application and all divisional, co which have been or shall be filed in the to all original and reissued patents wh	IETAL INTERCONNE entinuing, substitute e United States and ich have been or sh	CT LEVEL, AND PRO , renewal, reissue, an all foreign countries all be issued in the U	ECTRIC BETWEEN AT LEAST LOCAL OCESS FOR MAKING SAME" and in and all other applications for Letters Patent on any of said improvements; and in and United States and all foreign countries on of said United States application; and
when requested, without charge to representatives, to carry out in good f divisional, continuing, substitute, rene execute all rightful oaths, assignmen successors, assigns, and representati history thereof; and generally do everyt consider desirable for aiding in securing title to said improvements and all approvements are all approvements and all approvements and all approvements are all approvements and all approvements and all approvements and all approvements and all approvements are all all approvements are all all approvements are all all all all all all all all all al	o, but at the expetaith the intent and ewal, reissue, and alonts, powers of attoves, all facts know thing possible which g and maintaining polications to patents and the rights and pthe rights and p	nse of, said Assign purpose of this Assign I other patent applica- rney and other papen to the undersigned said Assignee, its su roper patent protecti- and all patents on a d legal representative roperty herein conv	inprovements in its own name; and that, nee, its successors, assigns and legal gnment, the undersigned will execute all ations on any and all said improvements; ers; communicate to said Assignee, its d relating to said improvements and the accessors, assigns or representatives shall on for said improvements and for vesting said improvements, in said Assignee, its res that no assignment, grant mortgage, eyed has been made to others by the assessed by the undersigned
Name: / / / / / / / / / / / Nicholas F. Pasch	Date: May 4	<u>/ / / / / ,</u> 1998	Witness: 1200 per Vacalla. Witness: 1200 per Vacalla.
Name: Rajat Rakkhit	Date: April 2	9, 1998 , ₁₉₉₈	Witness: Like Townshall Printed
Name:	Date:	, 1998	Witness:
	Data	1000	Printed
Name:	Date:	, 1998	Witness: Witness: Printed